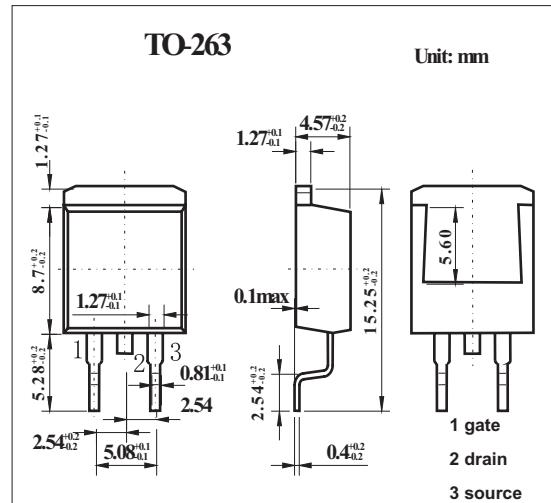
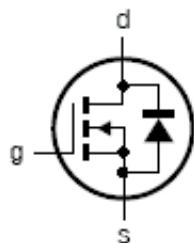


KUK7607-55B

■ Features

- Very low on-state resistance
- Q101 compliant
- 175°C rated
- Standard level compatible.



■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	Rating	Unit
Drain-source voltage	V _{DS}	55	V
Drain-gate voltage R _{GS} = 20 kΩ	V _{DGR}	55	V
Gate-source voltage	V _{GS}	±20	V
Drain current (DC) T _{mb} = 25°C, V _{GS} = 10 V	I _D	119	A
Drain current (DC) T _{mb} = 100°C, V _{GS} = 10 V	I _D	75	A
Drain current (pulse peak value) *1	I _{DM}	478	A
Total power dissipation T _{mb} = 25°C	P _{tot}	203	W
Storage & operating temperature	T _{stg} , T _j	-55 to 175	°C
reverse drain current (DC) T _{mb} = 25°C	I _{DR}	119	A
		75	A
pulsed reverse drain current *1	I _{DRM}	478	A
non-repetitive avalanche energy *2	E _{DS(AL)S}	351	J
Thermal resistance junction to mounting base	R _{th j-mb}	0.74	K/W
Thermal resistance junction to ambient	R _{th j-a}	50	K/W

* 1 T_{mb} = 25°C; pulsed; t_p ≤ 10 μs;

*2 unclamped inductive load; I_D = 75 A; V_{DS} ≤ 55 V; V_{GS} = 10 V; R_{GS} = 50Ω; starting T_{mb} = 25°C

KUK7607-55B

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Testconditons	Min	Typ	Max	Unit
drain-source breakdown voltage	V _{(BR)DSS}	I _D = 0.25 mA; V _{GS} = 0 V; T _j = 25°C	55			V
		I _D = 0.25 mA; V _{GS} = 0 V; T _j = -55°C	50			V
gate-source threshold voltage	V _{GS(th)}	I _D = 1 mA; V _{DS} = V _{GS} ; T _j = 25°C	2	3	4	V
		I _D = 1 mA; V _{DS} = V _{GS} ; T _j = 175°C	1			V
		I _D = 1 mA; V _{DS} = V _{GS} ; T _j = -55°C			4.4	V
Zero gate voltage drain current	I _{DSS}	V _{DS} = 55 V; V _{GS} = 0 V; T _j = 25°C		0.02	1	μA
		V _{DS} = 55 V; V _{GS} = 0 V; T _j = 175°C			500	μA
gate-source leakage current	I _{GSS}	V _{GS} = ±20 V; V _{DS} = 0 V		2	100	nA
drain-source on-state resistance	R _{DSON}	V _{GS} = 10 V; I _D = 25 A; T _j = 25°C	.	5.8	7.1	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 175°C			14.2	mΩ
total gate charge	Q _{G(tot)}	V _{GS} = 10 V; V _{DD} = 44 V; I _D = 25 A		53		nC
gate-to-source charge	Q _{GS}			12		nC
gate-to-drain (Miller) charge	Q _{Gd}			17		nC
input capacitance	C _{iss}	V _{GS} = 0 V; V _{DS} = 25 V; f = 1 MHz		2820	3760	pF
output capacitance	C _{oss}			554	665	pF
reverse transfer capacitance	C _{rss}			200	274	pF
turn-on delay time	t _{d(on)}	V _{DD} = 30 V; R _L = 1.2Ω; V _{GS} = 10 V; R _G = 10Ω		24		ns
rise time	t _r			52		ns
turn-off delay time	t _{d(off)}			77		ns
fall time	t _f			41		ns
internal drain inductance	L _d	from drain lead 6 mm from package to centre of die		4.5		nH
				2.5		nH
internal source inductance	L _s	from source lead to source bond pad		7.5		nH
source-drain (diode forward) voltage	V _{SD}	I _S = 40A; V _{GS} = 0 V		0.85	1.2	V
reverse recovery time	t _{rr}	I _S = 25 A; -dI/dt = -100 A/μs; V _{GS} = -10 V; V _{DS} = 30 V		62		ns
recovered charge	Q _r			60		nC